

### Field Effect Transistor

#### Silicon N Channel MOS Type ( $\pi$ -MOS III.5)

High Speed, High Current DC-DC Converter,  
Relay Drive and Motor Drive Applications

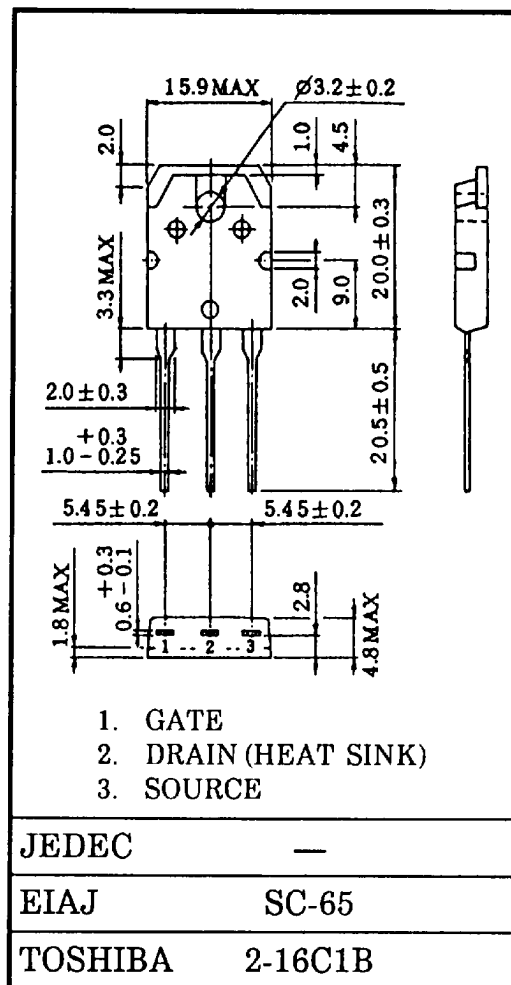
#### Features

- Low Drain-Source ON Resistance
  - $R_{DS(ON)} = 0.75\Omega$  (Typ.)
- High Forward Transfer Admittance
  - $|Y_{fs}| = 4.9S$  (Typ.)
- Low Leakage Current
  - $I_{DSS} = 300\mu A$  (Max.) @  $V_{DS} = 500V$
- Enhancement-Mode
  - $V_{th} = 2.0 \sim 4.0V$  @  $V_{DS} = 10V, I_D = 1mA$

#### Absolute Maximum Ratings (Ta = 25°C)

| CHARACTERISTIC                              | SYMBOL    | RATING    | UNIT |
|---|-----------|-----------|------|
| Drain-Source Voltage                        | $V_{DSS}$ | 500       | V    |
| Drain-Gate Voltage ( $R_{GS} = 20k\Omega$ ) | $V_{DGR}$ | 500       | V    |
| Gate-Source Voltage                         | $V_{GSS}$ | $\pm 30$  | V    |
| Drain Current                               | DC        | $I_D$     | 10   |
|   | Pulse     | $I_{DP}$  | 40   |
| Drain Power Dissipation<br>(Tc = 25°C)      | $P_D$     | 125       | W    |
| Channel Temperature                         | $T_{ch}$  | 150       | °C   |
| Storage Temperature Range                   | $T_{stg}$ | -55 ~ 150 | °C   |

Unit in mm



Weight : 4.6g

#### Thermal Characteristics

| CHARACTERISTIC                         | SYMBOL         | MAX. | UNIT |
|--|----------------|------|------|
| Thermal Resistance, Channel to Case    | $R_{th(ch-c)}$ | 1.0  | °C/W |
| Thermal Resistance, Channel to Ambient | $R_{th(ch-a)}$ | 50   | °C/W |

This transistor is an electrostatic sensitive device.  
Please handle with care.

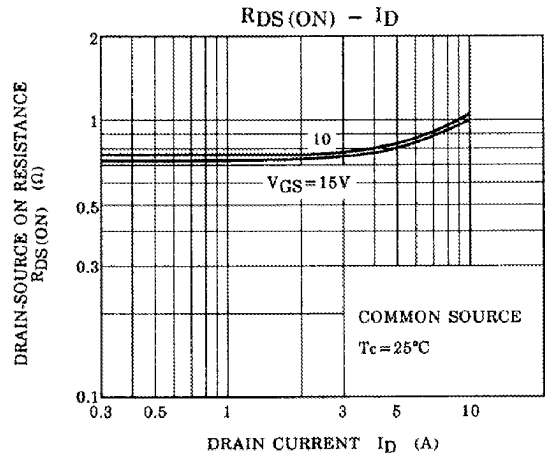
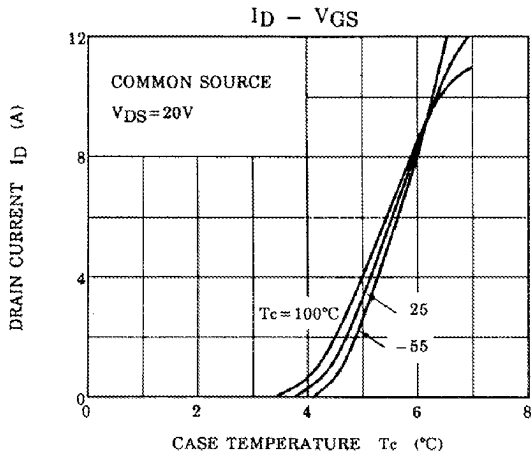
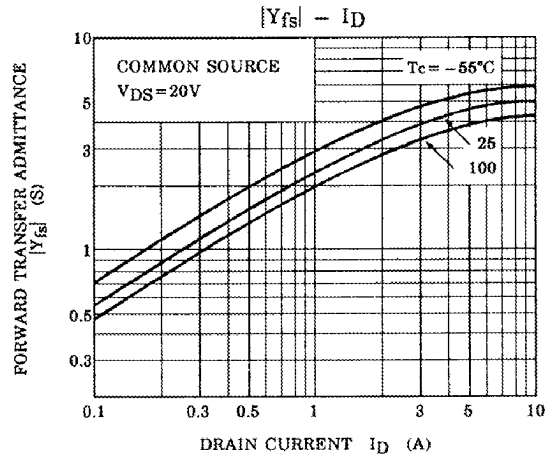
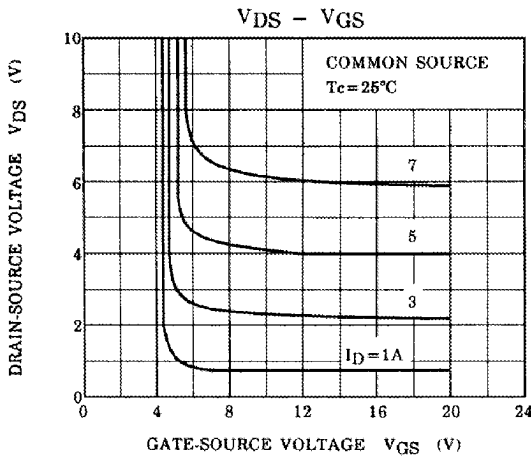
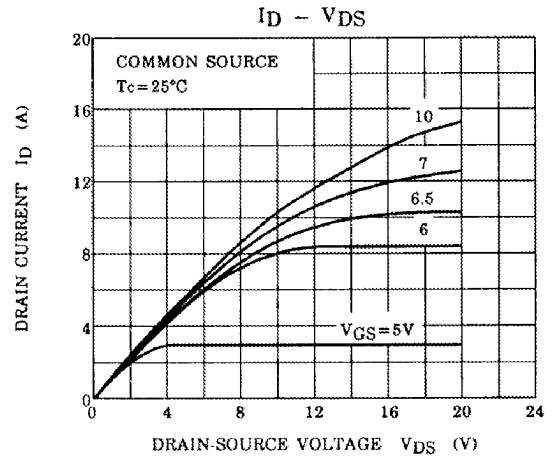
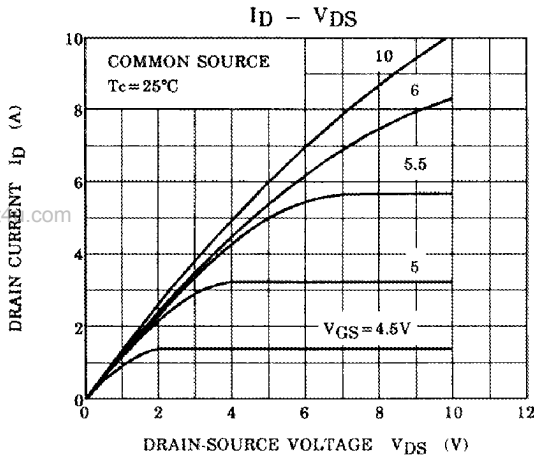
## Electrical Characteristics (Ta = 25°C)

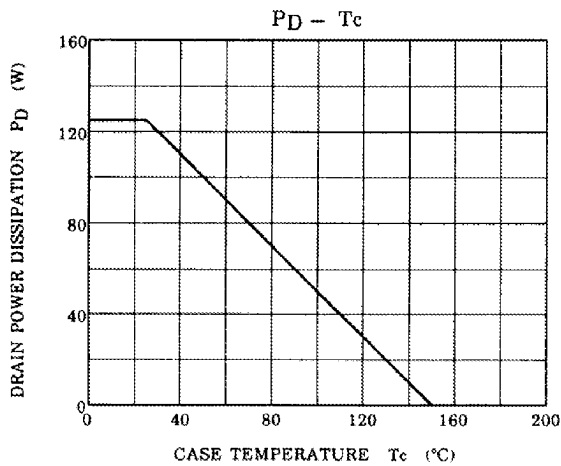
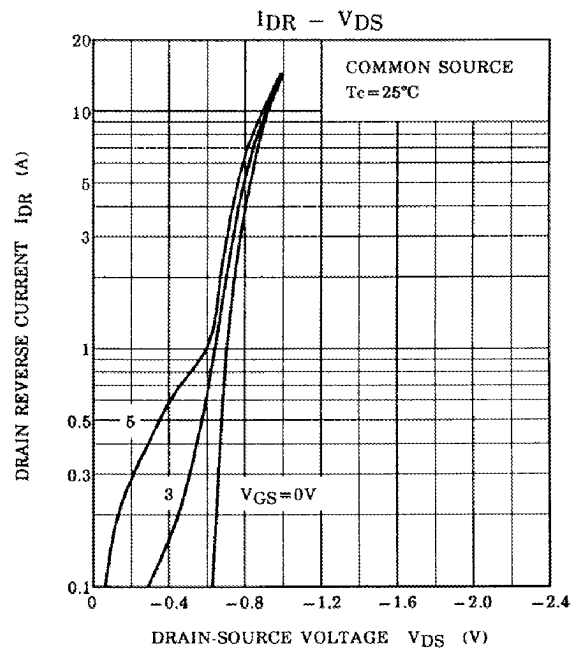
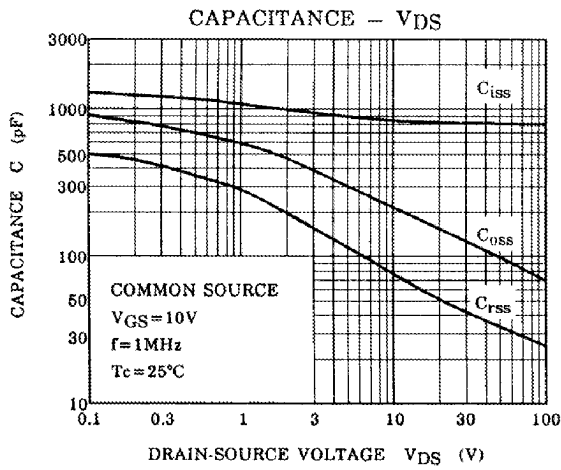
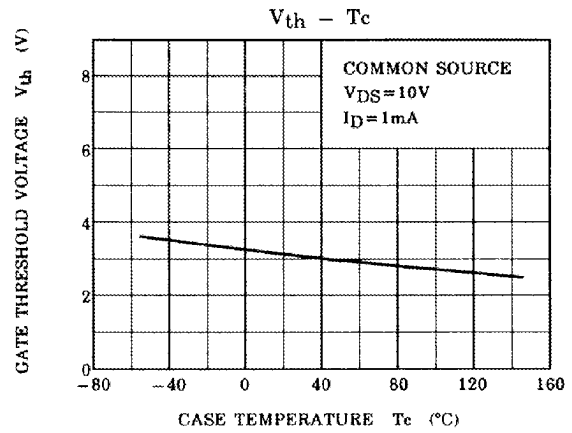
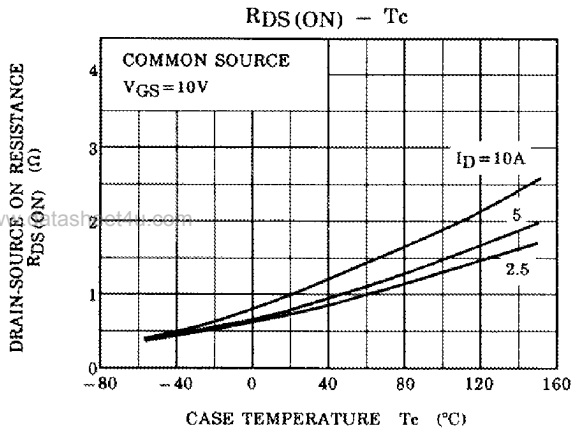
| CHARACTERISTIC                                  |               | SYMBOL         | TEST CONDITION  | MIN. | TYP. | MAX.      | UNIT     |
|---|---------------|----------------|---|------|------|-----------|----------|
| Gate Leakage Current                            |               | $I_{GSS}$      | $V_{GS} = \pm 30V, V_{DS} = 0V$   | -    | -    | $\pm 100$ | nA       |
| Drain Cut-off Current                           |               | $I_{DSS}$      | $V_{DS} = 500V, V_{GS} = 0V$  | -    | -    | 300       | $\mu A$  |
| Drain-Source Breakdown Voltage                  |               | $V_{(BR) DSS}$ | $I_D = 10mA, V_{GS} = 0V$   | 500  | -    | -         | V        |
| Gate Threshold Voltage                          |               | $V_{th}$       | $V_{DS} = 10V, I_D = 1mA$   | 2.0  | -    | 4.0       | V        |
| Drain-Source ON Resistance                      |               | $R_{DS(ON)}$   | $I_D = 5A, V_{GS} = 10V$  | -    | 0.75 | 1.0       | $\Omega$ |
| Forward Transfer Admittance                     |               | $ Y_{fs} $     | $V_{DS} = 10V, I_D = 5A$  | 3.0  | 4.9  | -         | S        |
| Input Capacitance                               |               | $C_{iss}$      | $V_{DS} = 10V, V_{GS} = 0V,$<br>$f = 1MHz$  | -    | 870  | 1100      | pF       |
| Reverse Transfer Capacitance                    |               | $C_{rss}$      |   | -    | 75   | 250       |          |
| Output Capacitance                              |               | $C_{oss}$      |   | -    | 210  | 300       |          |
| Switching Time                                  | Rise Time     | $t_r$          | <p><math>I_D = 5A</math><br/><math>V_{GS} = 10V</math><br/><math>R_L = 40\Omega</math><br/><math>V_{IN} : t_r, t_f &lt; 5ns, V_{DD} = 200V</math><br/><math>Duty \leq 1\%, t_w = 10\mu s</math></p> | -    | 30   | 90        | ns       |
|   | Turn-on Time  | $t_{on}$       |   | -    | 60   | 140       |          |
|   | Fall Time     | $t_f$          |   | -    | 35   | 130       |          |
|   | Turn-off Time | $t_{off}$      |   | -    | 100  | 300       |          |
| Total Gate Charge (Gate-Source Plus Gate-Drain) |               | $Q_g$          | $V_{DD} = 400V, V_{GS} = 10V,$<br>$I_D = 10A$   | -    | 40   | 85        | nC       |
| Gate-Source Charge                              |               | $Q_{gs}$       |   | -    | 16   | -         |          |
| Gate-Drain ("Miller") Charge                    |               | $Q_{gd}$       |   | -    | 24   | -         |          |

## Source-Drain Diode Ratings and Characteristics (Ta = 25°C)

| CHARACTERISTICS                  | SYMBOL    | TEST CONDITION              | MIN. | TYP. | MAX. | UNIT    |
|----------------------------------|-----------|-----------------------------|------|------|------|---------|
| Continuous Drain Reverse Current | $I_{DR}$  | -                           | -    | -    | 10   | A       |
| Pulse Drain Reverse Current      | $I_{DRP}$ | -                           | -    | -    | 40   | A       |
| Diode Forward Voltage            | $V_{DSF}$ | $I_{DR} = 10A, V_{GS} = 0V$ | -    | -    | -2.0 | V       |
| Reverse Recovery Time            | $t_{rr}$  | $I_{DR} = 10A, V_{GS} = 0V$ | -    | 360  | -    | ns      |
| Reverse Recovered Charge         | $Q_{rr}$  | $dI_{DR}/dt = 100A/\mu s$   | -    | 3.0  | -    | $\mu C$ |

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